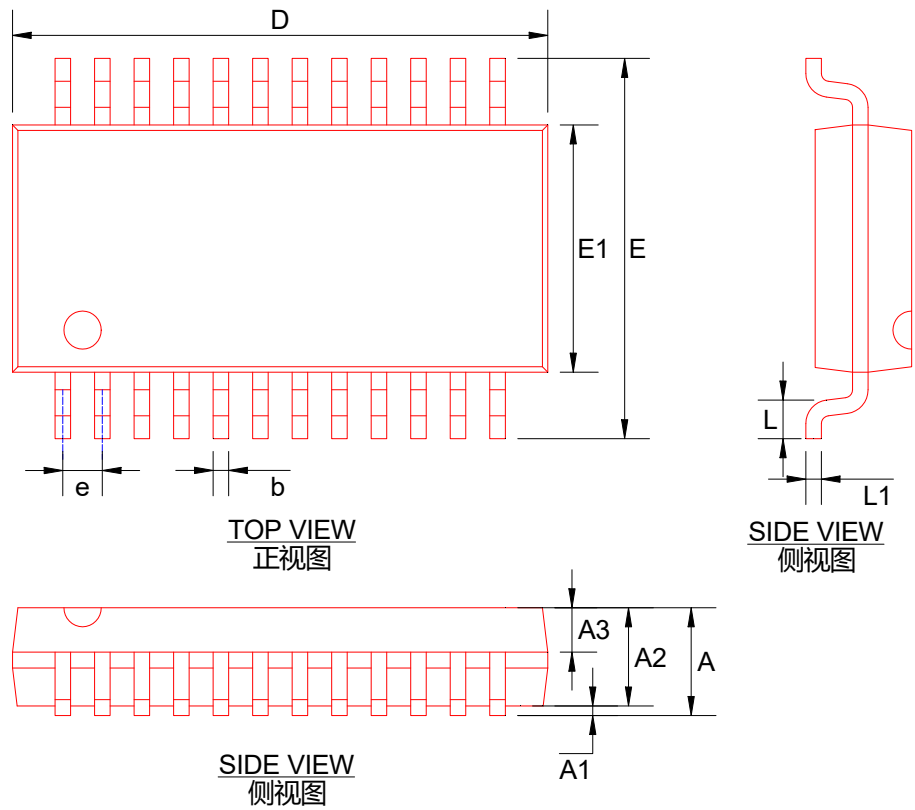


	深圳市锐骏半导体有限公司 ShenZhen Ruichips Semiconductor CO.,LTD	编号	RU-001-SSOP24-A-001
	封装外形尺寸（POD）规范	版本	A/0
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SSOP24



- NOTE:
- 1: ALL UNITS ARE IN MILLIMETER.
 - 2: EJECTOR PIN MARK POSITION MAY VARY FROM DIFFERENT MOLD.
 - 3: ALL DIMENSIONS REFER TO JEDEC.DO NOT INCLUDE MOLD FLASH OR

SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	—	—	1.700	—	—	0.067
A1	0.100	—	0.200	0.004	—	0.008
A2	1.350	1.450	1.550	0.053	0.057	0.061
A3	0.600	0.650	0.700	0.024	0.026	0.028
b	0.299	—	0.279	0.012	—	0.011
e	0.605	0.635	0.665	0.024	0.025	0.026
D	8.500	8.600	8.700	0.335	0.339	0.343
E	5.800	6.000	6.200	0.228	0.236	0.244
E1	3.800	3.900	4.000	0.150	0.154	0.157
L	0.500	0.600	0.700	0.020	0.024	0.028
L1	0.25BSC			0.010BSC		